

BGY885A

860 MHz, 18.5 dB push-pull amplifier Rev. 7 — 19 September 2011

Product data sheet

Product profile

1.1 General description

Hybrid amplifier module for CATV systems operating over a frequency range of 40 MHz to 860 MHz with a supply voltage of 24 V (DC).

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability

1.3 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G_p	power gain	f = 50 MHz	18	18.5	19	dB
		f = 860 MHz	18.5	19.5	-	dB
I _{tot}	total current consumption (DC)	$V_B = 24 V$	<u>[1]</u> _	225	240	mA

^[1] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.



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2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Symbol
1	input		
2	common	1 3 5 7 9	5
3	common		$\frac{1}{2}$ $\frac{9}{2}$
5	+V _B		2 3 7 8
7	common		sym095
8	common		,
9	output		

3. Ordering information

Table 3. Ordering information

Туре	Packag	е	
number	Name	Description	Version
BGY885A	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2×6 -32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{i}	RF input voltage		-	65	dBmV
T _{stg}	storage temperature		-40	+100	°C
T _{mb}	mounting base temperature		-20	+100	°C

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5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 860 MHz; $V_B = 24$ V; $T_{mb} = 30$ °C; $Z_S = Z_L = 75$ Ω ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz		18	18.5	19	dB
		f = 860 MHz		18.5	19.5	-	dB
SL	slope cable equivalent	f = 40 MHz to 860 MHz		0	8.0	2	dB
FL	flatness of frequency response	f = 40 MHz to 860 MHz		-	±0.2	±0.3	dB
s ₁₁	input return losses	f = 40 MHz to 80 MHz		20	31	-	dB
		f = 80 MHz to 160 MHz		18.5	30	-	dB
		f = 160 MHz to 320 MHz		17	27.5	-	dB
		f = 320 MHz to 640 MHz		15.5	25	-	dB
		f = 640 MHz to 860 MHz		14	20.5	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz		20	29	-	dB
		f = 80 MHz to 160 MHz		18.5	27.5	-	dB
		f = 160 MHz to 320 MHz		17	24	-	dB
		f = 320 MHz to 640 MHz		15.5	21	-	dB
		f = 640 MHz to 860 MHz		14	21	-	dB
Ψs21	phase response	f = 50 MHz		-45	-	+45	deg
СТВ	composite triple beat	49 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 859.25 MHz		-	-65	-61	dB
X _{mod}	cross modulation	49 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 55.25 MHz		-	-65	-61	dB
CSO	composite second order distortion	49 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 860.5 MHz		-	-67	-61	dB
d ₂	second order distortion		<u>[1]</u>	-	-78	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2]	58	60	-	dBmV
F	noise figure	f = 50 MHz		-	4.5	5	dB
		f = 450 MHz		-	-	5.5	dB
		f = 550 MHz		-	-	5.5	dB
		f = 600 MHz		-	-	6	dB
		f = 650 MHz		-	-	6	dB
		f = 750 MHz		-	-	7	dB
		f = 860 MHz		-	6	8	dB
I _{tot}	total current consumption (DC)		[3]	-	225	240	mA

^[1] $f_p = 55.25$ MHz; $V_p = 44$ dBmV; $f_q = 805.25$ MHz; $V_q = 44$ dBmV; measured at $f_p + f_q = 860.5$ MHz.

^[2] Measured according to DIN45004B: $f_p = 851.25$ MHz; $V_p = V_o$; $f_q = 858.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 860.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 849.25$ MHz.

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

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Table 6. Characteristics

Bandwidth 40 MHz to 750 MHz; $V_B = 24$ V; $T_{mb} = 30$ °C; $Z_S = Z_L = 75$ Ω ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G_p	power gain	f = 50 MHz	18	18.5	19	dB
		f = 750 MHz	18.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 750 MHz	0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 750 MHz	-	-	±0.3	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz	20	31	-	dB
		f = 80 MHz to 160 MHz	18.5	30	-	dB
		f = 160 MHz to 320 MHz	17	27.5	-	dB
		f = 320 MHz to 640 MHz	15.5	25	-	dB
		f = 640 MHz to 750 MHz	14	20.5	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz	20	29	-	dB
		f = 80 MHz to 160 MHz	18.5	27.5	-	dB
		f = 160 MHz to 320 MHz	17	24	-	dB
		f = 320 MHz to 640 MHz	15.5	21	-	dB
		f = 640 MHz to 750 MHz	14	21	-	dB
φ _{s21}	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	110 channels flat; $V_0 = 44$ dBmV; measured at 745.25 MHz	-	-55	-53	dB
X_{mod}	cross modulation	110 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 55.25 MHz	-	-58	–57	dB
CSO	composite second order distortion	110 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 746.5 MHz	-	-65	-53	dB
d_2	second order distortion		[1] _	-	-65	dB
V_{o}	output voltage	$d_{im} = -60 \text{ dB}$	<u>[2]</u> 59	-	-	dBmV
F	noise figure	see <u>Table 5</u>	-	-	-	dB
I _{tot}	total current consumption (DC)		[3]	225	240	mA

^[1] $f_p = 55.25 \text{ MHz}$; $V_p = 44 \text{ dBmV}$; $f_q = 691.25 \text{ MHz}$; $V_q = 44 \text{ dBmV}$; measured at $f_p + f_q = 746.5 \text{ MHz}$.

Table 7. Characteristics

Bandwidth 40 MHz to 600 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 30 \text{ °C}$; $Z_S = Z_L = 75 \Omega$; unless otherwise specified.

			-			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G_p	power gain	f = 50 MHz	18	18.5	19	dB
		f = 600 MHz	18.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 600 MHz	0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 600 MHz	-	-	±0.3	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz	20	31	-	dB
		f = 80 MHz to 160 MHz	18.5	30	-	dB
		f = 160 MHz to 320 MHz	17	27.5	-	dB
		f = 320 MHz to 600 MHz	16	25	-	dB

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^[2] Measured according to DIN45004B: $f_p = 740.25$ MHz; $V_p = V_o$; $f_q = 747.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 749.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 738.25$ MHz.

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

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Table 7. Characteristics ...continued

Bandwidth 40 MHz to 600 MHz; $V_B = 24$ V; $T_{mb} = 30$ °C; $Z_S = Z_L = 75$ Ω; unless otherwise specified.

0	B	0 !!d'		-	N	
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
S ₂₂	output return losses	f = 40 MHz to $80 MHz$	20	29	-	dB
		f = 80 MHz to 160 MHz	18.5	27.5	-	dB
		f = 160 MHz to 320 MHz	17	24	-	dB
		f = 320 MHz to 600 MHz	16	21	-	dB
Ψs21	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	85 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 595.25 MHz	-	-60	-57	dB
X_{mod}	cross modulation	85 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 55.25 MHz	-	-60.5	-59	dB
CSO	composite second order distortion	85 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 596.5 MHz	-	-64.5	-58	dB
d_2	second order distortion		[1] -	-79	-70	dB
V _o	output voltage	$d_{im} = -60 \text{ dB}$	^[2] 61	64.5	-	dBmV
F	noise figure	see Table 5	-	-	-	dB
I _{tot}	total current consumption (DC)		[3] _	225	240	mA

^[1] $f_p = 55.25$ MHz; $V_p = 44$ dBmV; $f_q = 541.25$ MHz; $V_q = 44$ dBmV; measured at $f_p + f_q = 596.5$ MHz.

Table 8. Characteristics
Bandwidth 40 MHz to 550 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 30 \text{ °C}$; $Z_S = Z_L = 75 \Omega$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	18	18.5	19	dB
		f = 550 MHz	18.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 550 MHz	0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 550 MHz	-	-	±0.3	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz	20	31	-	dB
		f = 80 MHz to 160 MHz	18.5	30	-	dB
		f = 160 MHz to 320 MHz	17	27.5	-	dB
		f = 320 MHz to 550 MHz	16	25	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz	20	29	-	dB
		f = 80 MHz to 160 MHz	18.5	27.5	-	dB
		f = 160 MHz to 320 MHz	17	24	-	dB
		f = 320 MHz to 550 MHz	16	21	-	dB
φs21	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	77 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 547.25 MHz	-	-61	-60	dB
X_{mod}	cross modulation	77 channels flat; $V_o = 44 \text{ dBmV}$; measured at 55.25 MHz	-	-61	-60	dB
CSO	composite second order distortion	77 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 548.5 MHz	-	-69	-60	dB

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^[2] Measured according to DIN45004B: f_p = 590.25 MHz; V_p = V_o ; f_q = 597.25 MHz; V_q = V_o - 6 dB; f_r = 599.25 MHz; V_r = V_o - 6 dB; measured at f_p + f_q - f_r = 588.25 MHz.

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

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Table 8. Characteristics ... continued

Bandwidth 40 MHz to 550 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 30 \text{ }^{\circ}\text{C}$; $Z_S = Z_L = 75 \Omega$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
d_2	second order distortion		<u>[1]</u> -	-	-72	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	^[2] 62	-	-	dBmV
F	noise figure	see <u>Table 5</u>	-	-	-	dB
I _{tot}	total current consumption (DC)		[3] _	225	240	mA

^[1] $f_p = 55.25$ MHz; $V_p = 44$ dBmV; $f_q = 493.25$ MHz; $V_q = 44$ dBmV; measured at $f_p + f_q = 548.5$ MHz.

Table 9. Characteristics

Bandwidth 40 MHz to 450 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 30 \text{ °C}$; $Z_S = Z_L = 75 \Omega$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	18	18.5	19	dB
		f = 450 MHz	18.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 450 MHz	0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 450 MHz	-	-	±0.3	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz	20	31	-	dB
		f = 80 MHz to 160 MHz	18.5	30	-	dB
		f = 160 MHz to 320 MHz	17	27.5	-	dB
		f = 320 MHz to 450 MHz	16	25	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz	20	29	-	dB
		f = 80 MHz to 160 MHz	18.5	27.5	-	dB
		f = 160 MHz to 320 MHz	17	24	-	dB
		f = 320 MHz to 450 MHz	16	21	-	dB
Ψs21	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	60 channels flat; $V_0 = 46 \text{ dBmV}$; measured at 445.25 MHz	-	-	-61	dB
X_{mod}	cross modulation	60 channels flat; $V_0 = 46 \text{ dBmV}$; measured at 55.25 MHz	-	-	-60	dB
CSO	composite second order distortion	60 channels flat; $V_0 = 46 \text{ dBmV}$; measured at 446.5 MHz	-	-	-61	dB
d ₂	second order distortion		<u>[1]</u> _	-	-75	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	2 64	-	-	dBmV
F	noise figure	see <u>Table 5</u>	-	-	-	dB
I _{tot}	total current consumption (DC)		[3]	225	240	mA

^[1] $f_p = 55.25$ MHz; $V_p = 46$ dBmV; $f_q = 391.25$ MHz; $V_q = 46$ dBmV; measured at $f_p + f_q = 446.5$ MHz.

^[2] Measured according to DIN45004B: f_p = 540.25 MHz; V_p = V_o ; f_q = 547.25 MHz; V_q = V_o - 6 dB; f_r = 549.25 MHz; V_r = V_o - 6 dB; measured at f_p + f_q - f_r = 538.25 MHz.

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

^[2] Measured according to DIN45004B: $f_p = 440.25$ MHz; $V_p = V_o$; $f_q = 447.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 449.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 438.25$ MHz.

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

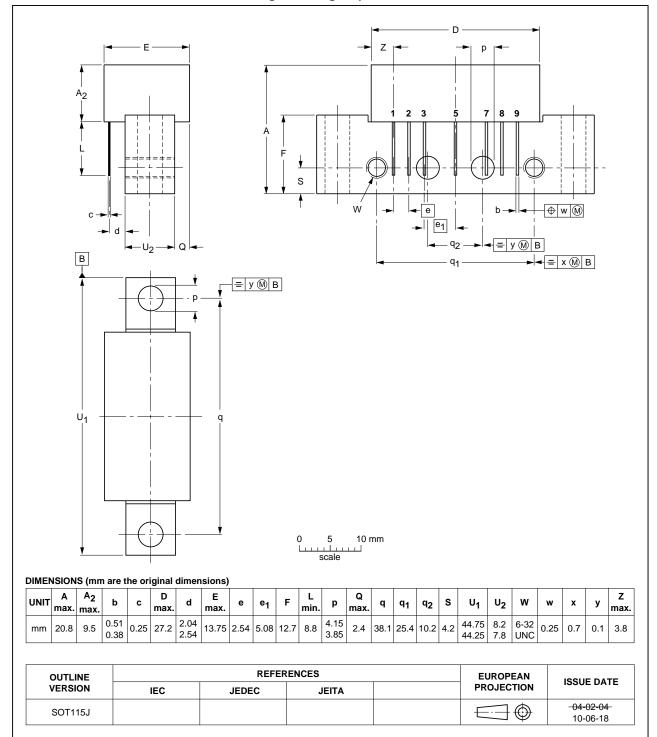


Fig 1. Package outline SOT115J

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7. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY885A v.7	20110919	Product data sheet	-	BGY885A v.6
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the n	ew company name whe	ere appropriate.
	 Package ou 	ıtline drawings have been u	pdated to the latest vers	sion.
BGY885A v.6 (9397 750 14434)	20050322	Product data sheet	-	BGY885A v.5
BGY885A v.5 (9397 750 08818)	20011022	Product specification	-	BGY885A v.4
BGY885A v.4 (9397 750 05444)	19990330	Product specification	-	BGY885A v.3
BGY885A v.3 (9397 750 02093)	19970407	Product specification	-	BGY885A v.2
BGY885A v.2	19950201	Product specification	-	n.a.

8. Legal information

8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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NXP Semiconductors



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